# XN01210 (XN1210)

### Silicon NPN epitaxial planer transistor

#### For switching/digital circuits

#### Features

- Two elements incorporated into one package. (Emitter-coupled transistors with built-in resistor)
- Reduction of the mounting area and assembly cost by one half.
- Transistor with built-in resistor

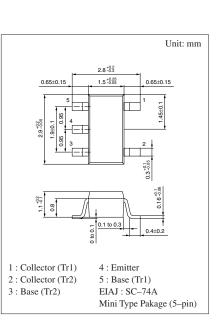
#### Basic Part Number of Element

• UNR1210(UN1210)  $\times$  2 elements

Parameter		Symbol	Ratings	Unit			
Rating of element	Collector to base voltage	V <sub>CBO</sub>	50	V			
	Collector to emitter voltage	V <sub>CEO</sub>	50	V			
	Collector current	I <sub>C</sub>	100	mA			
Overall	Total power dissipation	P <sub>T</sub>	300	mW			
	Junction temperature	$T_j$	150	°C			
	Storage temperature	T <sub>stg</sub>	-55 to +150	°C			

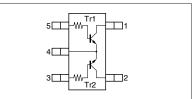
#### Absolute Maximum Ratings (Ta=25°C)

Electrical Characteristics (Ta=25°C)



#### Marking Symbol: AC

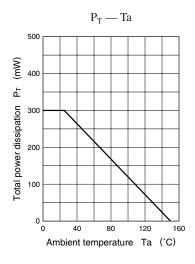
#### Internal Connection

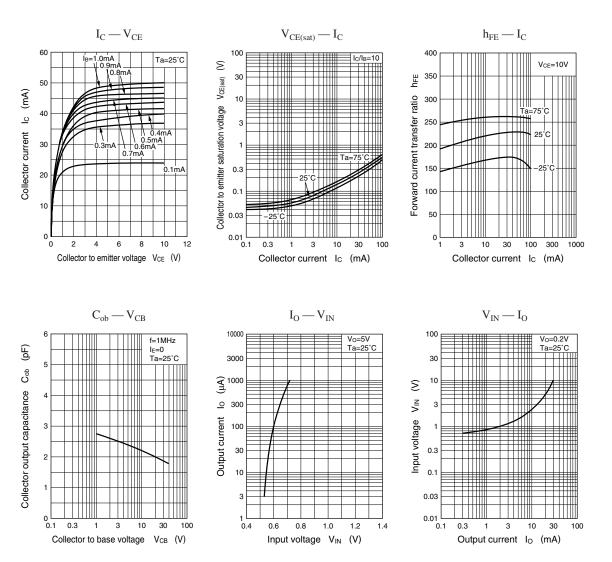


Parameter	Symbol	Conditions	min	typ	max	Unit
Collector to base voltage	V <sub>CBO</sub>	$I_{\rm C} = 10\mu A, I_{\rm E} = 0$	50			V
Collector to emitter voltage	V <sub>CEO</sub>	$I_C = 2mA, I_B = 0$	50			V
Collector cutoff current	I <sub>CBO</sub>	$V_{CB} = 50V, I_E = 0$			0.1	μΑ
Collector cutoff current	I <sub>CEO</sub>	$V_{CE} = 50V, I_B = 0$			0.5	μΑ
Emitter cutoff current	I <sub>EBO</sub>	$V_{EB} = 6V, I_C = 0$			0.01	mA
Forward current transfer ratio	h <sub>FE</sub>	$V_{CE} = 10V, I_C = 5mA$	160		460	
Forward current transfer $h_{FE}$ ratio	h <sub>FE</sub> (small/large)*1	$V_{CE} = 10V, I_{C} = 5mA$	0.5	0.99		
Collector to emitter saturation voltage	V <sub>CE(sat)</sub>	$I_{\rm C} = 10 {\rm mA}, I_{\rm B} = 0.3 {\rm mA}$			0.25	V
Output voltage high level	V <sub>OH</sub>	$V_{CC} = 5V$ , $V_B = 0.5V$ , $R_L = 1k\Omega$	4.9			V
Output voltage low level	V <sub>OL</sub>	$V_{CC} = 5V, V_B = 2.5V, R_L = 1k\Omega$			0.2	V
Transition frequency	f <sub>T</sub>	$V_{CB} = 10V, I_E = -2mA, f = 200MHz$		150		MHz
Input resistance	R <sub>1</sub>		-30%	47	+30%	kΩ

\*1 Ratio between 2 elements

Note.) The Part number in the Parenthesis shows conventional part number.





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